

XL6001

Features

- Wide 3.6V to 24V Input Voltage Rang
- 0.22V Constant Current Sense Voltage
- Directly drive 3~8 Series 1W LED
- Fixed 400KHz Switching Frequency
- Max. 2A Switching Current Capability
- Up to 92% efficiency
- Excellent line and load regulation
- EN PIN TTL shutdown capability
- Internal Optimize Power MOSFET
- Built in LED Open Protection
- Built in Soft-Start Function
- Built in Frequency Compensation
- Built in Thermal Shutdown Function
- Built in Current Limit Function
- Available in SOP8 package

General Description

The XL6001 regulator is fixed frequency PWM Boost (step-up) LED constant current driver, capable of driving Series 1W LED units with excellent line and load regulation. The regulator is simple to use because it includes internal frequency compensation and a fixed-frequency oscillator so that it requires a minimum number of external components to work.

The XL6001 could directly drive 5~8 Series 1W LED units at VIN>12V.

The PWM control circuit is able to adjust the duty ratio linearly from 0 to 90%. An enable function, an over current protection function is built inside. An internal compensation block is built in to minimize external component count.

Applications

- LED Lighting
- Boost constant current driver
- Monitor LED Backlighting
- 7' to 15' LCD Panels



SOIC-8

Figure 1. Package Type of XL6001



XL6001

Pin Configurations

EN	1	XL6001	8	GND
VIN	2		7	GND
FB	3		6	SW
NC	4		5	SW

Figure 2. Pin Configuration of XL6001 (Top View)

Table 1 Pin Description

Pin Number	Pin Name	Description
1	EN	Enable Pin. Drive EN pin low to turn off the device, drive it
1		high to turn it on. Floating is default high.
		Supply Voltage Input Pin. XL6001 operates from a 3.6V to 24V
2	VIN	DC voltage. Bypass Vin to GND with a suitably large capacitor
		to eliminate noise on the input.
3	FB	Feedback Pin (FB). The feedback threshold voltage is 0.22V.
4	NC	No Connected.
5,6	SW	Power Switch Output Pin (SW). Output is the switch node that
		supplies power to the output.
7,8	GND	Ground Pin.



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Function Block

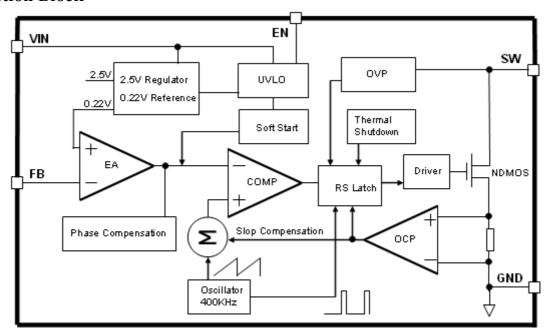


Figure 3. Function Block Diagram of XL6001

Typical Application Circuit

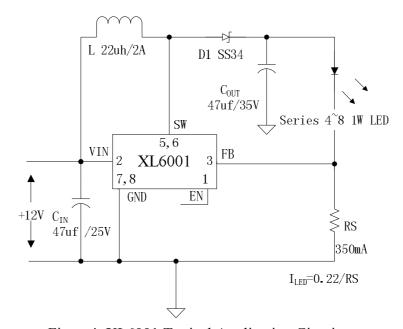


Figure 4. XL6001 Typical Application Circuit



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Ordering Information

Order Information	Marking ID	Package Type	Packing Type Supplied As
XL6001E1	XL6001E1	SOP-8L	2500 Units on Tape & Reel

XLSEMI Pb-free products, as designated with "E1" suffix in the par number, are RoHS compliant.

Absolute Maximum Ratings (Note1)

Parameter	Symbol	Value	Unit
Input Voltage	Vin	-0.3 to 26	V
Feedback Pin Voltage	V_{FB}	-0.3 to Vin	V
EN Pin Voltage	V_{EN}	-0.3 to Vin	V
Output Switch Pin Voltage	V_{Output}	-0.3 to 32	V
Power Dissipation	P_{D}	Internally limited	mW
Thermal Resistance (SOP8)	R_{JA}	100	°C/W
(Junction to Ambient, No Heatsink, Free Air)	ΝJΑ	100	<i>C7 11</i>
Operating Junction Temperature	T_{J}	-40 to 125	°C
Storage Temperature	T_{STG}	-65 to 150	°C
Lead Temperature (Soldering, 10 sec)	T_{LEAD}	260	°C
ESD (HBM)		>2000	V

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.



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XL6001 Electrical Characteristics

 $T_a = 25$ °C; unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
System parameters test circuit figure4						
VFB	Feedback Voltage	, and the second		220	231	mV
Efficiency	ŋ	Vin=12V ,Vout= 6*1W LED Iout=0.3A	- 92		-	%

Electrical Characteristics (DC Parameters)

Vin = 12V, GND=0V, Vin & GND parallel connect a 47uf/25V capacitor; Iout=50mA, $T_a = 25$ °C; the others floating unless otherwise specified.

Parameters	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Input operation voltage	Vin		3.6		24	V
Shutdown Supply Current	I_{STBY}	$V_{EN}=0V$		70	100	uA
Quiescent Supply Current	I_q	$V_{EN} = 2V,$ $V_{FB} = V_{ID}$		2.5	5	mA
Oscillator Frequency	Fosc		320	400	480	Khz
Switch Current Limit	I_L	$V_{FB} = 0$		2		A
Output Power NMOS	Rdson	Vin=12V, I _{SW} =2A		110	120	mohm
EN Pin Threshold	$V_{\rm EN}$	High (Regulator ON) Low (Regulator OFF)		1.4 0.8		V
EN Pin Input Leakage	I_{H}	$V_{EN} = 2V (ON)$		3	10	uA
Current	I_L	$V_{EN} = 0V (OFF)$		3	10	uA
Max. Duty Cycle	D_{MAX}	$V_{FB}=0V$		90		%



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Schottky Diode Selection Table

Current	Surface	Through	VR (The same as system maximum input voltage)				
	Mount	Hole					
			20V	30V	40V	50V	60V
1A		√	1N5817	1N5818	1N5819		
			•		-		
		√	1N5820	1N5821	1N5822		
		√	MBR320	MBR330	MBR340	MBR350	MBR360
3A	√		SK32	SK33	SK34	SK35	SK36
JA .	√			30WQ03	30WQ04	30WQ05	
		√		31DQ03	31DQ04	31DQ05	
		√	SR302	SR303	SR304	SR305	SR306

Typical System Application for VIN=5V to driver 2~6 x 1W series LED units

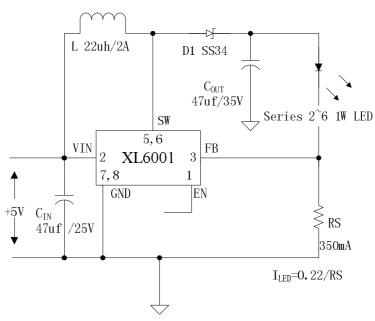


Figure 5. XL6001 System Parameters Test Circuit (2~6 x 1W LED)



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Typical System Application for VIN=12V to driver 4~8 x 1W series LED units

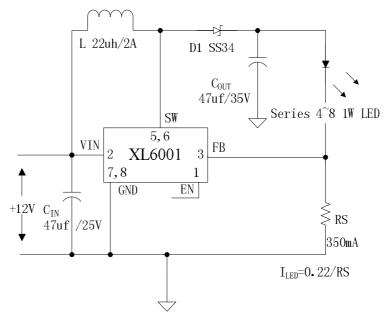


Figure 6. XL6001 System Parameters Test Circuit (4~8 x 1W LED)

Typical System Application for VIN=12V to driver 4~8 x 1W series LED units With PWM Dimming

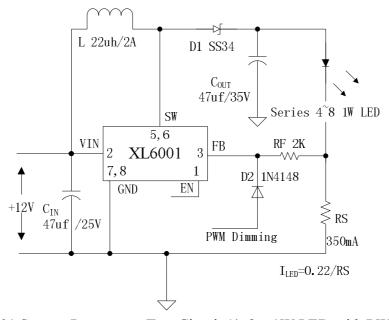


Figure 7. XL6001 System Parameters Test Circuit (4~8 x 1W LED with PWM Dimming)



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Typical System Application for SEPIC Buck-Boost LED Driver

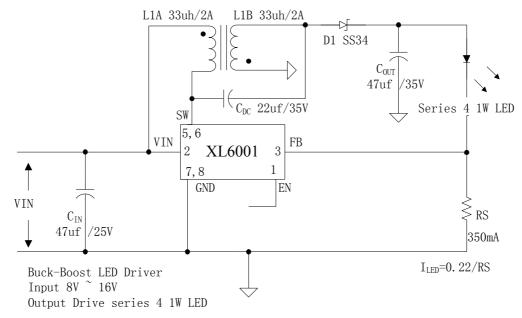


Figure 8. XL6001 System Parameters Test Circuit (Buck-Boost LED Driver)



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Package Information

SOP8 Package Mechanical Dimensions

SOIC-8 Unit: mm(inch)

